

# CAT4004

## 4-Channel Constant Current LED Driver with EZDim™

### Description

The CAT4004 provides four matched low dropout current sources to drive LEDs. An external resistor on RSET sets the current in the LED channels. Each LED channel includes an individual control loop allowing the device to handle a wide range of LED forward voltages while still maintaining tight current matching.

The EN/DIM logic inputs supports device enable and a digital dimming interface for current setting of all LEDs. Six different current dimming ratios are available.

The device is aimed at “direct drive” battery applications. It is required that the battery or voltage source have enough headroom to drive the LED forward voltage and current sink (>150 mV).

The device is available in a tiny 8-lead TDFN 2 mm x 3 mm package with a max height of 0.8 mm.

### Features

- Four LED Current Sinks with Tight Matching
- Low Dropout Driver 130 mV at 30 mA
- No Switching Noise
- Shutdown Current < 1  $\mu$ A
- LED Current set by External Resistor
- Dimming via 1-wire EZDim™ Interface
- Thermal Shutdown Protection
- 8-lead 2 mm x 3 mm TDFN Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### Applications

- LCD Display Backlight
- Cellular Phones
- Digital Still Cameras
- Handheld Devices

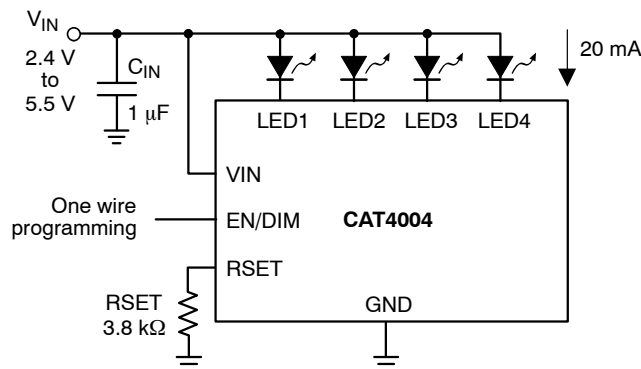


Figure 1. Typical Application Circuit



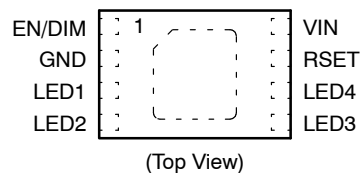
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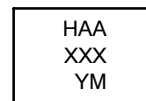
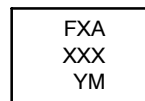


TDFN-8  
VP2 SUFFIX  
CASE 511AK

### PIN CONNECTIONS



### MARKING DIAGRAMS



FX = CAT4004VP2-T3  
HA = CAT4004VP2-GT3  
A = Assembly Location  
XXX = Last Three Digits of Assembly Lot Number  
Y = Production Year (Last Digit)  
M = Production Month (1-9, A, B, C)

### ORDERING INFORMATION

Device	Package	Shipping
CAT4004VP2-T3 (Note 1)	TDFN-8 (Pb-Free)	3,000/ Tape & Reel
CAT4004VP2-GT3 (Note 2)	TDFN-8 (Pb-Free)	3,000/ Tape & Reel

1. Matte-Tin Plated Finish (RoHS-compliant).
2. NiPdAu Plated Finish (RoHS-compliant).

# CAT4004

**Table 1. ABSOLUTE MAXIMUM RATINGS**

Parameter	Rating	Unit
V <sub>IN</sub> , LED <sub>x</sub> , RSET	6	V
EN/DIM Voltage	V <sub>IN</sub> + 0.7	V
Storage Temperature Range	-65 to +160	°C
Junction Temperature Range	-40 to +150	°C
Lead Temperature	300	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

**Table 2. RECOMMENDED OPERATING CONDITIONS**

Parameter	Rating	Unit
V <sub>IN</sub>	2.4 to 5.5	V
Ambient Temperature Range	-40 to +85	°C
I <sub>LED</sub> per LED pin	0 to 40	mA

NOTE: Typical application circuit with external components is shown on page 1.

**Table 3. ELECTRICAL OPERATING CHARACTERISTICS**

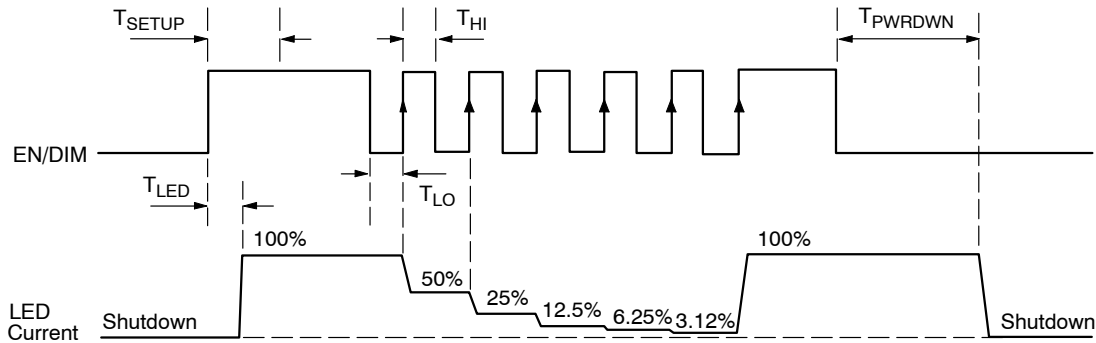
(over recommended operating conditions unless specified otherwise) V<sub>IN</sub> = 4.0 V, EN = High, T<sub>AMB</sub> = 25°C

Symbol	Name	Conditions	Min	Typ	Max	Units
I <sub>Q</sub>	Quiescent Current	No load, RSET = Float No load, RSET = 4.8 kΩ		0.6 1.0		mA
I <sub>QSHDN</sub>	Shutdown Current	V <sub>EN</sub> = 0 V			1	μA
I <sub>LED-ACC</sub>	LED Current Accuracy	1 mA ≤ I <sub>LED</sub> ≤ 40 mA		±1		%
I <sub>LED-DEV</sub>	LED Channel Matching	$\frac{I_{LED} - I_{LEDAVG}}{I_{LED}}$	-5	±1	+5	%
V <sub>DOUT</sub>	Dropout Voltage	I <sub>LED</sub> = 30 mA		130		mV
R <sub>EN/DIM</sub> V <sub>HI</sub> V <sub>LO</sub>	EN/DIM Pin – Internal pull-down resistor – Logic High Level – Logic Low Level		1.3	100	0.4	kΩ V V
T <sub>SD</sub>	Thermal Shutdown			150		°C
T <sub>HYS</sub>	Thermal Hysteresis			20		°C
V <sub>UVLO</sub>	Undervoltage lockout (UVLO) threshold			1.8		V

**Table 4. RECOMMENDED EN/DIM TIMING**

(For  $2.4 \leq V_{IN} \leq 5.5$  V, over full ambient temperature range  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .)

Symbol	Name	Conditions	Min	Typ	Max	Units
$T_{SETUP}$	EN/DIM setup from shutdown		10			$\mu\text{s}$
$T_{LO}$	EN/DIM program low time		0.2		100	$\mu\text{s}$
$T_{HI}$	EN/DIM program high time		0.2			$\mu\text{s}$
$T_{PWRDWN}$	EN/DIM low time to shutdown		1.5			ms
$T_{LED}$	LED current settling time			40		$\mu\text{s}$



**Figure 2. EN/DIM Dimming Timing Diagram**

EN/DIM Number of Pulses (Note 3)	R <sub>SET</sub> Gain	LED Current
LOW	Shutdown mode	Zero
Transitions HIGH	132	$132 \times 0.6 \text{ V/R}_{SET}$
1 <sup>st</sup>	66	$66 \times 0.6 \text{ V/R}_{SET}$
2 <sup>nd</sup>	33	$33 \times 0.6 \text{ V/R}_{SET}$
3 <sup>rd</sup>	16.5	$16.5 \times 0.6 \text{ V/R}_{SET}$
4 <sup>th</sup>	8.25	$8.25 \times 0.6 \text{ V/R}_{SET}$
5 <sup>th</sup>	4.125	$4.125 \times 0.6 \text{ V/R}_{SET}$
6 <sup>th</sup>	132	$132 \times 0.6 \text{ V/R}_{SET}$
x <sup>th</sup>	Device will keep cycling through gain selection	$\text{GAIN} \times 0.6 \text{ V/R}_{SET}$

3. The gain is changed on the rising edges of the EN/DIM input.

**LED Current Selection**

At power-up, the initial LED current is set to full scale (100% brightness) by the external resistor R<sub>SET</sub> as follows:

$$\text{LED current} = 132 \times \frac{0.6 \text{ V}}{R_{SET}}$$

The EN/DIM pin has two primary functions. One function enables and disables the device. The other function is LED current dimming with six different levels by pulsing the

input signal, as shown on Figure 2. On each consecutive pulse rising edge, the LED current is divided by half to 50%, then 25%, 12.5%, 6.25% and 3.125% dimming levels. Pulses faster than the minimum T<sub>LO</sub> may be ignored and filtered by the device. Pulses longer than the maximum T<sub>LO</sub> may shutdown the device.

The LED driver enters a “zero current” shutdown mode if EN/DIM is held low for 1.5 ms or more.

# CAT4004

## TYPICAL PERFORMANCE CHARACTERISTICS

( $V_{IN} = 4\text{ V}$ ,  $V_F = 3.3\text{ V}$ ,  $I_{OUT} = 80\text{ mA}$  (4 LEDs at 20 mA),  $C_{IN} = 1\text{ }\mu\text{F}$ ,  $T_{AMB} = 25^\circ\text{C}$  unless otherwise specified.)

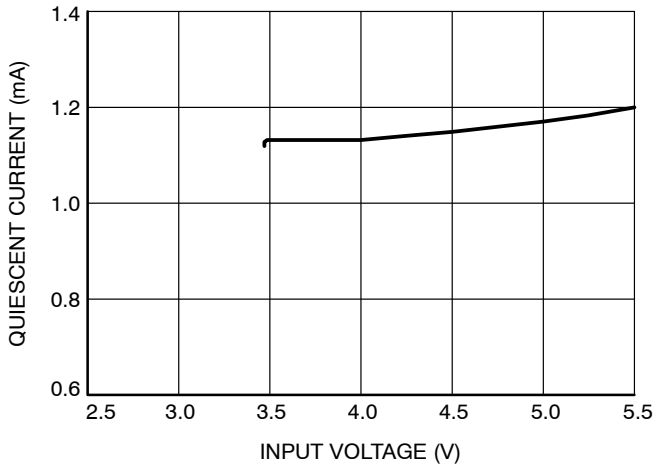


Figure 3. Quiescent Current vs. Input Voltage

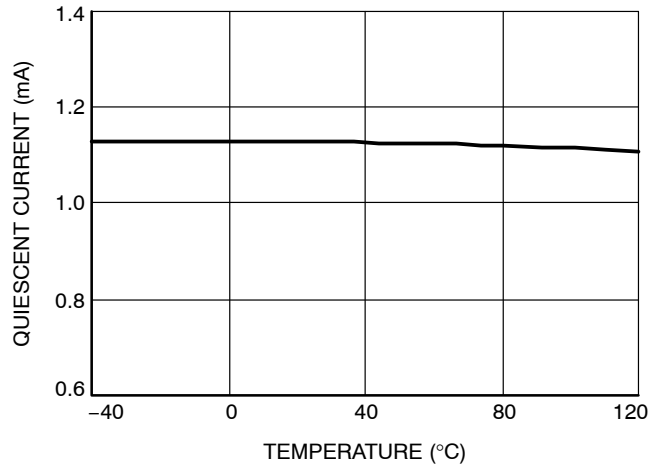


Figure 4. Quiescent Current vs. Temperature

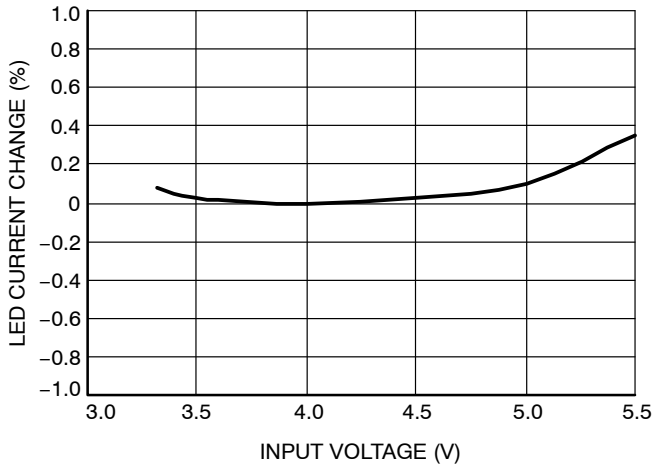


Figure 5. LED Current Change vs. Input Voltage

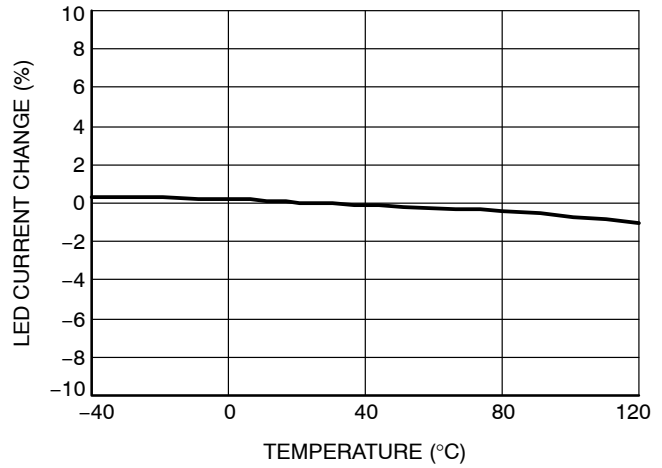


Figure 6. LED Current Change vs. Temperature

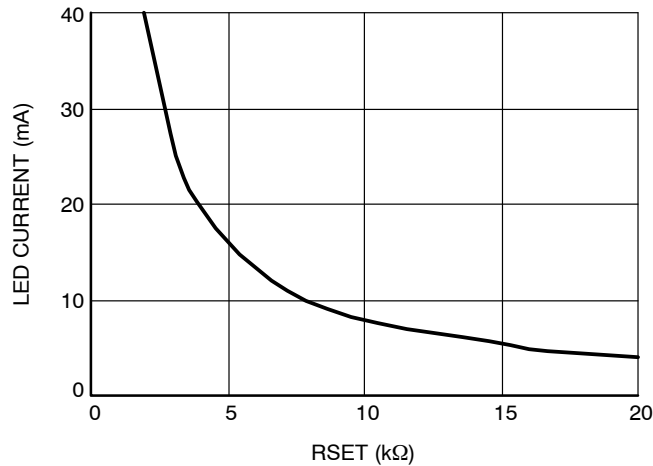


Figure 7. LED Current vs. RSET Resistor

# CAT4004

## TYPICAL PERFORMANCE CHARACTERISTICS

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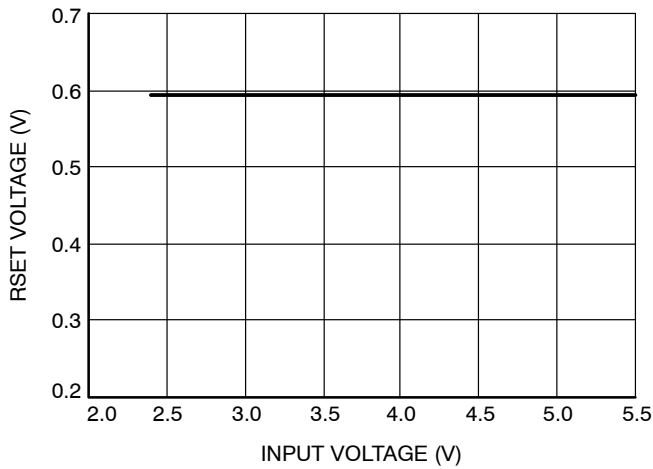


Figure 8. RSET Pin Voltage vs. Input Voltage

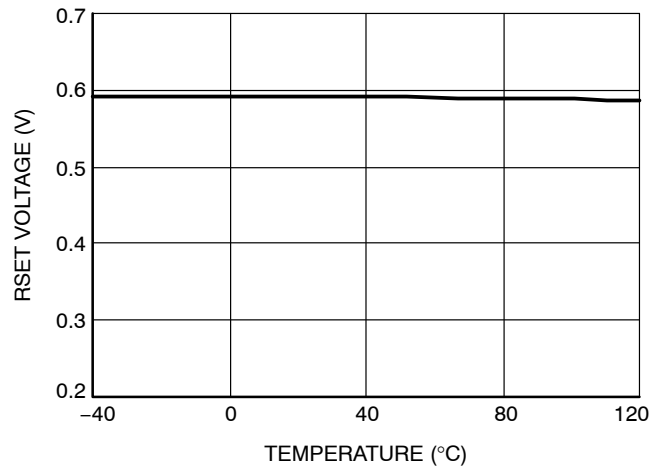


Figure 9. RSET Pin Voltage vs. Temperature

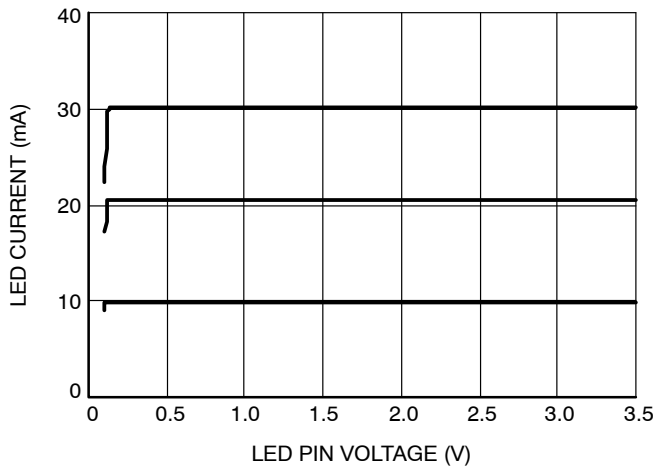


Figure 10. LED Current vs. LED Pin Voltage

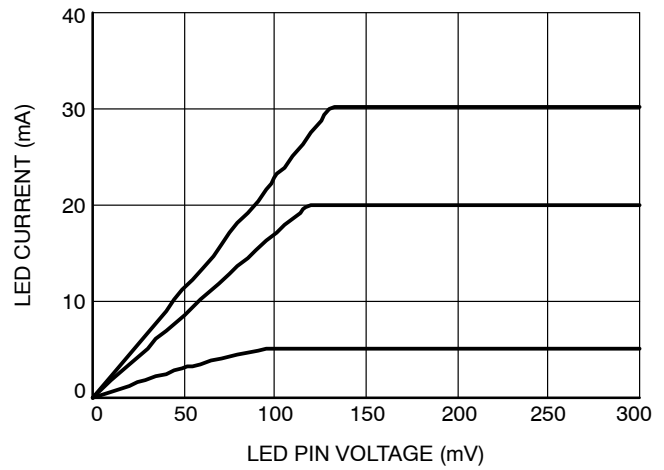


Figure 11. Dropout Characteristics

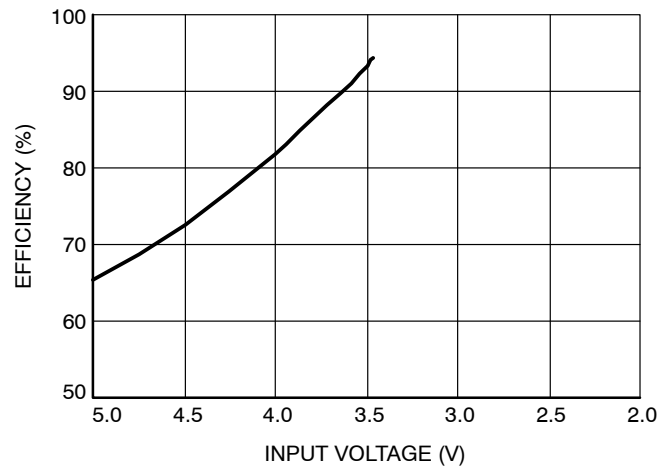


Figure 12. Efficiency vs. Input Voltage

# CAT4004

## TYPICAL PERFORMANCE CHARACTERISTICS

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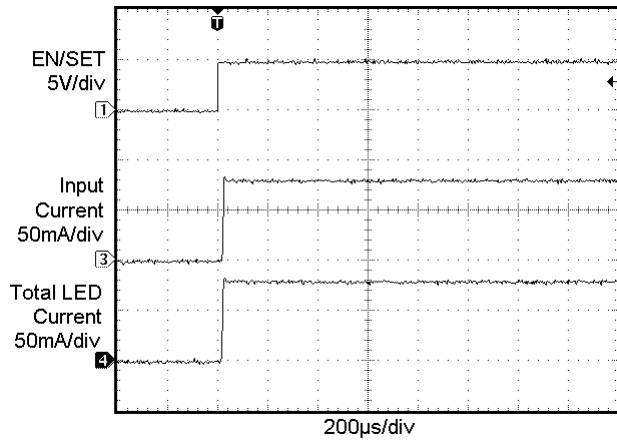


Figure 13. Power Up Waveform

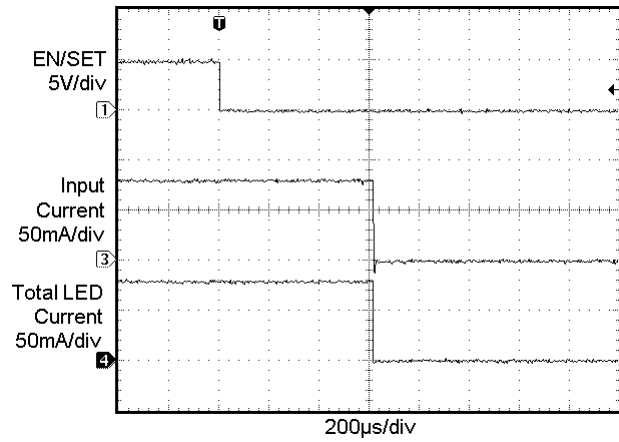


Figure 14. Power Down Waveform

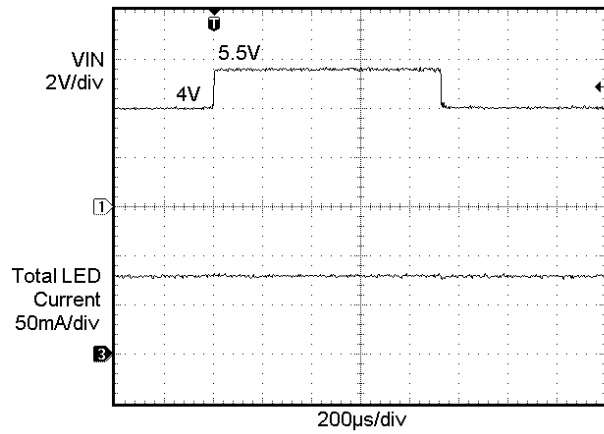


Figure 15. Line Transient Waveform  
4 V to 5.5 V

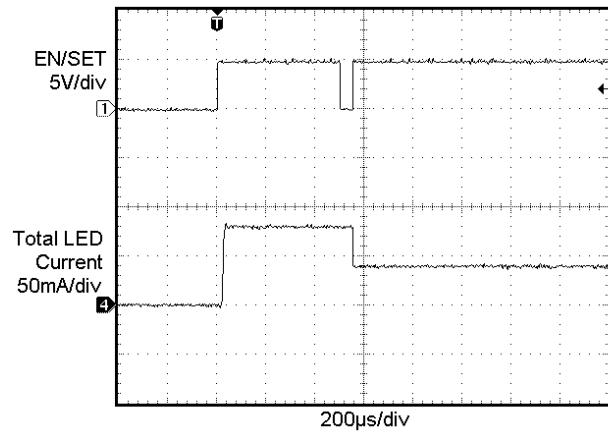


Figure 16. Dimming Waveform 80 mA to 40 mA

Table 5. PIN DESCRIPTIONS

Pin #	Name	Function
1	EN/DIM	Device enable (active high) and dimming control
2	GND	Ground reference
3	LED1	LED1 cathode terminal
4	LED2	LED2 cathode terminal
5	LED3	LED3 cathode terminal
6	LED4	LED4 cathode terminal
7	RSET	RSET external LED mirror gain 128
8	VIN	Device supply input, connect to battery or supply
TAB	TAB	Connect to GND on the PCB

**Pin Function**

**VIN** is the supply pin for the device logic. A small 1  $\mu$ F ceramic bypass capacitor is required between the VIN pin and ground near the device. The operating input voltage range is from 2.5 V to 5.5 V. Whenever the input supply falls below the under-voltage threshold (1.8 V), all the LED channels are disabled and the device enters shutdown mode.

**EN/DIM** is the enable and one wire dimming input for all LED channels. Levels of logic high and logic low are set at 1.3 V and 0.4 V respectively. When EN/DIM is initially taken high, the device becomes enabled and all LED currents are set to the full scale according to the resistor RSET. To place the device into “zero current” shutdown mode, the EN/DIM pin must be held low for at least 1.5 ms.

**LED1 to LED4** provide the internal regulated current for each of the LED cathodes. These pins enter a high

impedance zero current state whenever the device is placed in shutdown mode.

**RSET** is connected to the resistor (RSET) to set the full scale current for the LEDs. The voltage at this pin is regulated to 0.6 V. The ground side of the external resistor should be star connected back to the GND of the PCB. In shutdown mode, RSET becomes high impedance.

**GND** is the ground reference for the device. The pin must be connected to the ground plane on the PCB.

**TAB** is the exposed pad underneath the package. For best thermal performance, the tab should be soldered to the PCB and connected to the ground plane.

# CAT4004

## Block Diagram

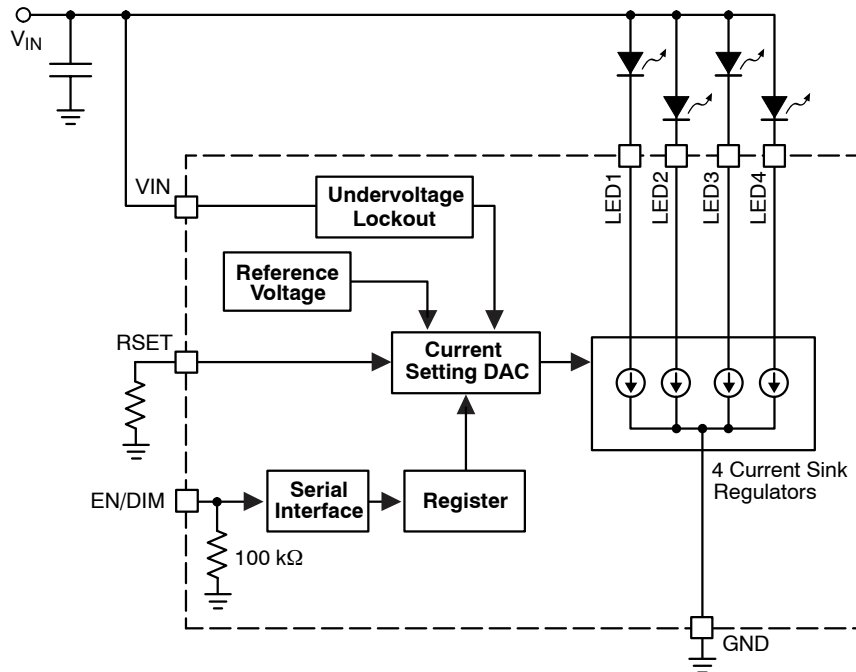


Figure 17. CAT4004 Functional Block Diagram

## Basic Operation

The CAT4004 uses four tightly matched current sinks to accurately regulate LED current in each channel proportional to the current sourced from the RSET pin.

$$I_{LED} = GAIN \times \frac{0.6 V}{R_{SET}}$$

There are six different gain settings for LED brightness that can be set through the EN/DIM pin. The default gain on

power-up is 132. Tight current regulation for all channels is possible over a wide range of input and LED voltages due to independent current sensing circuitry on each channel.

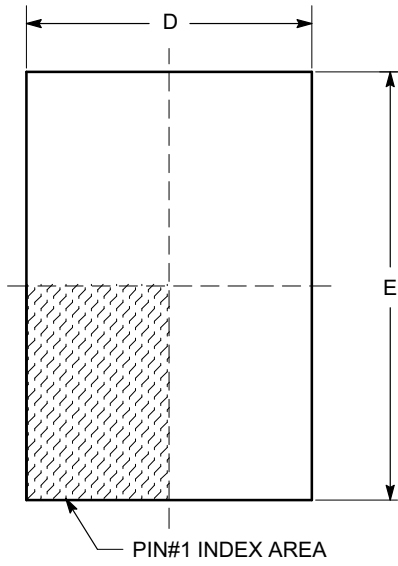
Each LED channel needs a minimum of 150 mV headroom to sink constant regulated current. If the input supply falls below 1.8 V, the under-voltage lockout circuit disables all LED channels and resets the circuit to default values. Any unused LED channels should be left open.



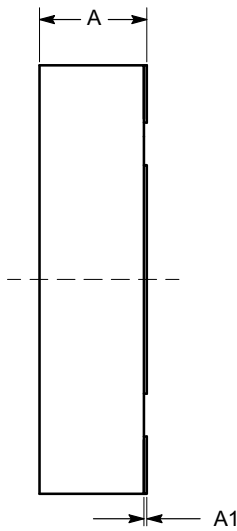
# CAT4004

## PACKAGE DIMENSIONS

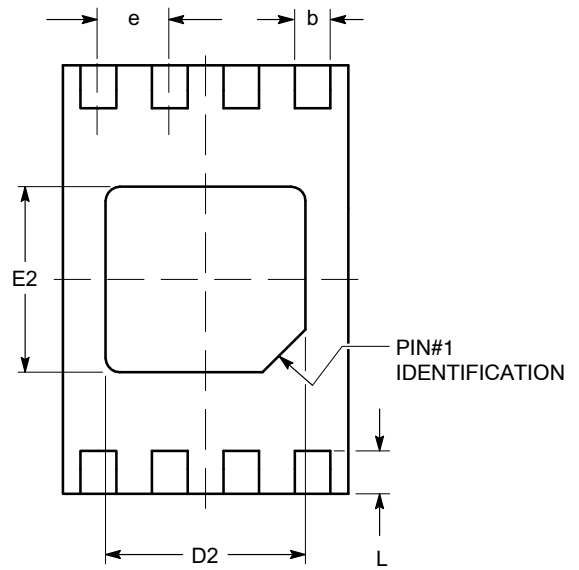
TDFN8, 2x3  
CASE 511AK-01  
ISSUE A



TOP VIEW

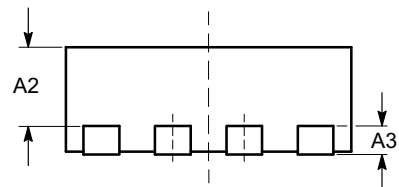


SIDE VIEW



BOTTOM VIEW

SYMBOL	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2	0.45	0.55	0.65
A3	0.20 REF		
b	0.20	0.25	0.30
D	1.90	2.00	2.10
D2	1.30	1.40	1.50
E	2.90	3.00	3.10
E2	1.20	1.30	1.40
e	0.50 TYP		
L	0.20	0.30	0.40



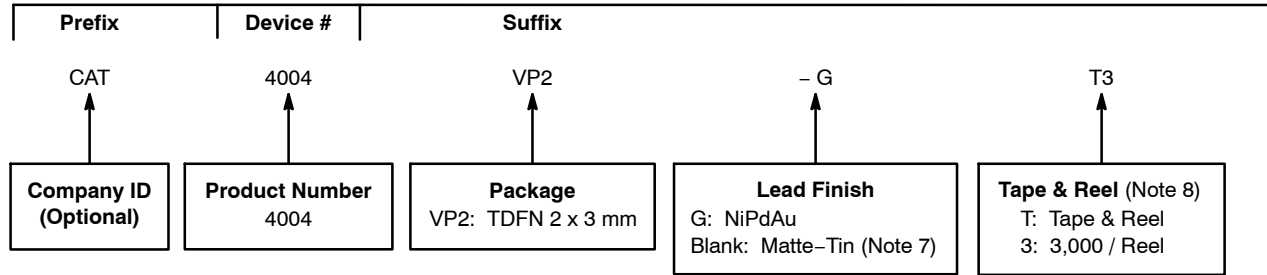
FRONT VIEW

**Notes:**


- (1) All dimensions are in millimeters.
- (2) Complies with JEDEC MO-229.

# CAT4004

## Example of Ordering Information (Note 6)



- All packages are RoHS-compliant (Lead-free, Halogen-free).
- The standard lead finish is NiPdAu.
- The device used in the above example is a CAT4004VP2-GT3 (TDFN, NiPdAu Plated Finish, Tape & Reel, 3,000/Reel).
- For Matte-Tin package option, please contact your nearest ON Semiconductor Sales office.
- For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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